┰┼	COUNT	DESCRIPTION	OF REVISION	UNS	BY	CHKD	DATE	<u> </u>	DUNT				CHKD	DAT	<u></u>
<del>\</del>						<del> </del>									
APP	LICAB	LE STAND	DARD_	<u> </u>					STORA	OF .					
		TEMPERATU OPERATING	RE RANGE	te range   -35 °C TO +85 °C(NOTE1)   TEMP						PERATURE RANGE   -10 °C TO +60 °C					
RA	TING	MOISTURE R	ANGE	20	. %T	O 80 '	%(NOTE	£ <b>2</b> )	MOIST	TURE RANGE 40 %TO 70 %(NO				TES	3)_
	· <u> </u>	CURREN	1T	1 A VO					VOL	LTAGE 150 V AC(				C)	
						SP	ECIFIC	CATI	ONS	<u> </u>					
	ITE	EM	T		TES	T MET	THOD			F	REQUIREM	ENTS	(	QT	АТ
CON	<b>ISTRL</b>	JCTION													
		AMINATION					RING INSTR	RUMEN.	T. A	ACCORDIN	IG TO DRAWIN	iG.		×	X
MARK	KING		CONFIRMED VISUALLY.											×	Х
		CHARAC													
CONT	FACT RE	SISTANCE	100 mA (	DC OF	₹ 1000	Hz)			3	30 mΩ MAX	<b>.</b>				
CONTACT RESISTANCE MILLIVOLT LEVEL			20 mV MAX, 1mA (DC OR 1000Hz)											×	
	LATION STANCE	**************************************	100 V DC.							500 MΩ MIN.				×	
	AGE PR		500 V AC	FOR	1 min.				1	OFLASH(	OVER OR BRE	AKDOWN.		$\frac{1}{X}$	
MEC	CHANI	CAL CHAI	RACTE	RIST	ICS									$\stackrel{\frown}{-}$	
MECHANICAL OPERATION			50 TIMES INSERTIONS AND EXTRACTIONS.							<ol> <li>CONTACT RESISTANCE: 30 mΩ MAX.</li> <li>NO DAMAGE, CRACK OR LOOSENESS OF PARTS.</li> </ol>				×	
VIBR#	ATION						SINGLE AM		)E (i	-	CTRICAL DISC	ONTINUIT	Y OF	$\Box$	
SHOC	SK .		490 m/s <sup>2</sup> FOR 3 DI	DURA	TION	OF PUL	SE 11 ms A	AT 3 TII	MES @	1 μs. ② NO DAM OF PART	MAGE, CRACK (	OR LOOSE	ENESS	×	
ENV	/IRONI	MENTAL (	CHARA	CTEI	RIST	ics								I	
	D CHANG						5 →+85 →		1/2		CT RESISTANC			T	
TEMPERATURE			TIME 30 →10 TO 15 →30 →10 TO15min UNDER 5 CYCLES.						in (2	DINSULAT MIN.	TION RESISTA	NCE: 500 I		$_{\times}$	
	P HEAT ADY STA	.TE)	EXPOSED AT 40 ± 2 °C, 90 ~ 95 %, 96 h.						Ç,		IAGE, CRACK (	OR LOOSE	1		
RESIS	STANCE		(1) REFL			RING				IO DEFORI	MATION OF CA			×	_
SOLDI HEAT	ERING		《REFLO MAX 25			VITHIN 1	10 -00		- 1	EXCESSIVE FERMINALS	E LOOS <b>EN</b> ESS S.	OF THE			
l 16			MIN 23			VITHIN 1				EINIVIDA	<b>3</b> .				
			⟨PREHE	EATING	3 ARE	Α»			1				ł		
							To 120 sec. W FUMACE		.e						
			PUT THROUGH IN REFLOW FUMACE TWICE. LEAVE IN AMBIENT TEMPERATURE AND						E.						
			HUMIDITY FOR 1 HOUR.												
							URE TO BE	5							
			AMBIENT FOR SECOND REFLOW. (2) MANUAL SOLDERING SOLDERING IRON TEMPERATURE												
			1			i±1 sec. I CONTA									
SOLD	ERABILI	TY	NO STRENGTH ON CONTACT.  SOLDERING TEMPERATURE: 235±5°C							NEW UNI	FORM COATIN	G OF SOL	.DER		
			DURATIO						- 1	SHALL COVER MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.					_
			SOLDERI	NG, re	JR 3 s	sec.		DR	S AWN	DESIGNE	T		OVED BI	ELEA	SED
REMA	ARKS	DING THE TE		URE R	ISE B	Y CURR	KENT.	010	.48814	DEGIÇITA	ED   OHLONES	)   Allin	JAED LV	الدائدة	9EL
NOTE			•												
NOTE:	1:INCLUI 2:NON-C	CONDENSING TO THE CO	=	DE LOI	IC TE	PM STC				4.0-1-	with.	11000	, ,		
NOTE:	1:INCLUI 2:NON-C 3:APPLY FOR UI	TO THE CO	NDITION (	EFORE	PCB	ON BOA	ARD,	1. 2 %	4 4 .		WWW I Property	1 11/14	agari		
NOTE:	1:INCLUI 2:NON-C 3:APPLY FOR UI AFTER	TO THE CO NUSED PROI PCB BOARD	NDITION ( DUCTS BE D,OPERAT	EFORE	PCB EMPE	ON BOA	ARD,	Fr Mu	etarki	J. Hango		100	7		
NOTE:	1:INCLUI 2:NON-C 3:APPLY FOR UI AFTER HUMID	TO THE CO	NDITION ( DUCTS BE D,OPERAT IS APPLIEI	EFORE ING TE D FOR	PCB EMPEI INTEI	ON BOA	ARD,	F. Mu	etaiki	1	mya T. Miyayi		2		
NOTE: NOTE:	E1:INCLUI E2:NON-C E3:APPLY FOR UI AFTER HUMIDI STORA	TO THE CO NUSED PRO PCB BOARD TY RANGE I	NDITION ODUCTS BE DOPERAT IS APPLIED TRANSPO	EFORE TING TE ED FOR ORTAT	PCB EMPEI INTEI ION.	ON BOA RATURE RIM	ARD,		etaiki = . 17	53.3		13.0	2 3,=3		
NOTE: NOTE: NOTE:	:1:INCLUI :2:NON-C :3:APPLY FOR UI AFTER HUMIDI STORA ss other	TO THE CO NUSED PROI PCB BOARD ITY RANGE I AGE DURING	NDITION ( DUCTS BE D,OPERAT IS APPLIEI TRANSPO ified, refe	EFORE ING TE D FOR ORTAT Er to J	PCB EMPEI INTEI ION. IS C 5	ON BOA RATURE RIM 5402	ARD,	03,		£3.3.	7 83,03,2	5 27.0	3,-5		
NOTE: NOTE: NOTE:	E1:INCLUI E2:NON-C E3:APPLY FOR UI AFTER HUMID STORA SS OTHER QT:Qual	TO THE CO NUSED PROI PCB BOARD ITY RANGE I AGE DURING TWISE SPECI	NDITION ( DUCTS BE D,OPERAT IS APPLIEI TRANSPO ified, refe	EFORE ING TE D FOR ORTAT Er to J	EPCB EMPEI INTEI ION. IS C 5	ON BOA RATURE RIM 5402 ×:Appli	ARD, E AND	03,	5.7	\$3.3 /	7	5 27.00			
NOTE: NOTE: Unles	E1:INCLUI E2:NON-C E3:APPLY FOR UI AFTER HUMID STORA SS OTHER QT:Qual	TO THE CO NUSED PROI PCB BOARD TY RANGE I AGE DURING Wise speci Iffication Test	NDITION OF DUCTS BE COMMENT OF SECURIC OF THE COMMENT OF THE COMME	EFORE ING TE D FOR ORTAT Er to J	E PCB EMPEI INTEI ION. IS C 5 Test	ON BOA RATURE RIM 5402 ×:Appli	ARD, E AND	03,	5.7	EET PAI	7	* P-1.2			4 .7
NOTE: NOTE: Unles	E1:INCLUI E2:NON-C E3:APPLY FOR UI AFTER HUMID STORA SS other QT:Qual	TO THE CO NUSED PROI PCB BOARD TY RANGE I AGE DURING Wise speci Iffication Test	NDITION OF DUCTS BE COMMENT OF SECURIC OF THE COMMENT OF THE COMME	EFORE FING TE D FOR ORTAT ET to J  Irance CO., L  RAWING	E PCB EMPEI INTEI ION. IS C 5 Test .TD.	ON BOARATURE RIM  5402  ×:Appli  SPE	ARD, E AND	OB,	, '7 <b>∨</b> SH	EET PAI	7	* P-1.2			